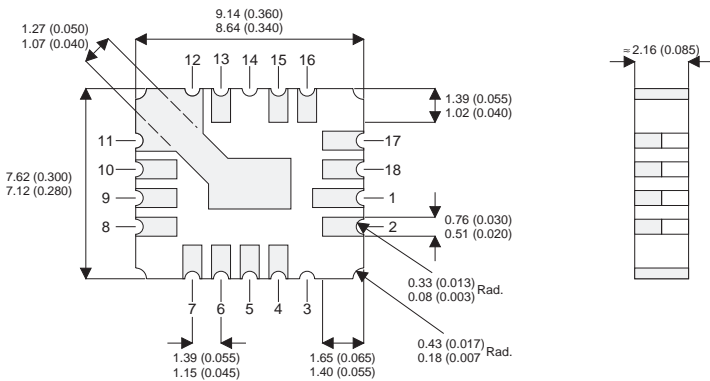


MECHANICAL DATA

Dimensions in mm (inches)

**N-CHANNEL
POWER MOSFET**



V_{DSS} **200V**
 $I_{D(cont)}$ **4.8A**
 $R_{DS(on)}$ **0.46Ω**

FEATURES

- SURFACE MOUNT
- SMALL FOOTPRINT
- HERMETICALLY SEALED
- DYNAMIC dv/dt RATING
- AVALANCHE ENERGY RATING
- SIMPLE DRIVE REQUIREMENTS
- LIGHT WEIGHT

LCC4

MOSFET	TRANSISTOR	PINS
GATE	BASE	4,5
DRAIN	COLLECTOR	1,2,15,16,17,18
SOURCE	EMITTER	6,7,8,9,10,11,12,13

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$ unless otherwise stated)

V_{GS}	Gate – Source Voltage	$\pm 20V$
I_D	Continuous Drain Current ($V_{GS} = 10V, T_{case} = 25^{\circ}C$)	4.8A
I_D	Continuous Drain Current ($V_{GS} = 10V, T_{case} = 100^{\circ}C$)	3.1A
I_{DM}	Pulsed Drain Current ¹	19A
P_D	Power Dissipation @ $T_{case} = 25^{\circ}C$	22W
	Linear Derating Factor	0.17W/ $^{\circ}C$
E_{AS}	Single Pulse Avalanche Energy ²	54mJ
dv/dt	Peak Diode Recovery ³	4.5V/ns
T_J, T_{stg}	Operating and Storage Temperature Range	-55 to +150 $^{\circ}C$
	Surface Temperature (for 5 sec).	300 $^{\circ}C$

Notes

- 1) Pulse Test: Pulse Width $\leq 300\mu s, \delta \leq 2\%$
- 2) @ $V_{DD} = 50V, L \geq 570\mu H, R_G = 25\Omega, Peak I_L = 14A, Starting T_J = 25^{\circ}C$
- 3) @ $I_{SD} \leq 14A, di/dt \leq 140A/\mu s, V_{DD} \leq BV_{DSS}, T_J \leq 150^{\circ}C, Suggested R_G = 7.5\Omega$

ELECTRICAL CHARACTERISTICS ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
STATIC ELECTRICAL RATINGS					
BV_{DSS} Drain – Source Breakdown Voltage	$V_{\text{GS}} = 0$ $I_{\text{D}} = 1\text{mA}$	200			V
$\frac{\Delta BV_{\text{DSS}}}{\Delta T_{\text{J}}}$ Temperature Coefficient of Breakdown Voltage	Reference to 25°C $I_{\text{D}} = 1\text{mA}$		0.25		$\text{V}/^{\circ}\text{C}$
$R_{\text{DS(on)}}$ Static Drain – Source On-State Resistance ¹	$V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 3.1\text{A}$			0.40	Ω
	$V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 4.8\text{A}$			0.46	
$V_{\text{GS(th)}}$ Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ $I_{\text{D}} = 250\text{mA}$	2		4	V
g_{fs} Forward Transconductance ¹	$V_{\text{DS}} \geq 15\text{V}$ $I_{\text{DS}} = 3.1\text{A}$	2.5			S ($\bar{\cup}$)
I_{DSS} Zero Gate Voltage Drain Current	$V_{\text{GS}} = 0$ $V_{\text{DS}} = 0.8BV_{\text{DSS}}$ $T_{\text{J}} = 125^{\circ}\text{C}$			25	μA
				250	
I_{GSS} Forward Gate – Source Leakage	$V_{\text{GS}} = 20\text{V}$			100	nA
I_{GSS} Reverse Gate – Source Leakage	$V_{\text{GS}} = -20\text{V}$			-100	
DYNAMIC CHARACTERISTICS					
C_{iss} Input Capacitance	$V_{\text{GS}} = 0$		600		pF
C_{oss} Output Capacitance	$V_{\text{DS}} = 25\text{V}$		250		
C_{riss} Reverse Transfer Capacitance	$f = 1\text{MHz}$		80		
Q_{g} Total Gate Charge	$V_{\text{GS}} = 10\text{V}$	7.4		42.1	nC
Q_{gs} Gate – Source Charge	$I_{\text{D}} = 4.8\text{A}$	2.5		5.3	
Q_{gd} Gate – Drain (“Miller”) Charge	$V_{\text{DS}} = 0.5BV_{\text{DSS}}$	6.0		28.1	
$t_{\text{d(on)}}$ Turn-On Delay Time	$V_{\text{DD}} = 100\text{V}$ $I_{\text{D}} = 4.8\text{A}$ $R_{\text{G}} = 7.5\Omega$			30	ns
t_{r} Rise Time				50	
$t_{\text{d(off)}}$ Turn-Off Delay Time				50	
t_{f} Fall Time				40	
SOURCE – DRAIN DIODE CHARACTERISTICS					
I_{S} Continuous Source Current				4.8	A
I_{SM} Pulse Source Current ²				19	
V_{SD} Diode Forward Voltage ¹	$I_{\text{S}} = 4.8\text{A}$ $T_{\text{J}} = 25^{\circ}\text{C}$ $V_{\text{GS}} = 0$			1.4	V
t_{rr} Reverse Recovery Time	$I_{\text{F}} = 4.8\text{A}$ $T_{\text{J}} = 25^{\circ}\text{C}$			6.0	ns
Q_{rr} Reverse Recovery Charge ¹	$d_i / d_t \leq 100\text{A}/\mu\text{s}$ $V_{\text{DD}} \leq 50\text{V}$			3.0	μC
t_{on} Forward Turn-On Time			Negligible		
PACKAGE CHARACTERISTICS					
L_{D} Internal Drain Inductance (measured from 6mm down drain lead to centre of die)			1.8		nH
L_{S} Internal Source Inductance (from 6mm down source lead to source bond pad)			4.3		
THERMAL CHARACTERISTICS					
$R_{\theta\text{JC}}$ Thermal Resistance Junction – Case				5.8	$^{\circ}\text{C}/\text{W}$
$R_{\theta\text{JPC}}$ Thermal Resistance Junction – PC Board				19	

Notes

- 1) Pulse Test: Pulse Width $\leq 300\text{ms}$, $\delta \leq 2\%$
- 2) Repetitive Rating – Pulse width limited by maximum junction temperature.